



# STE180NE10

N-channel 100V - 4.5mΩ - 180A - ISOTOP  
STripFET™ Power MOSFET

## General features

Type	V <sub>DSS</sub>	R <sub>DS(on)</sub>	I <sub>D</sub>
STE180NE10	100V	<6mΩ	180A

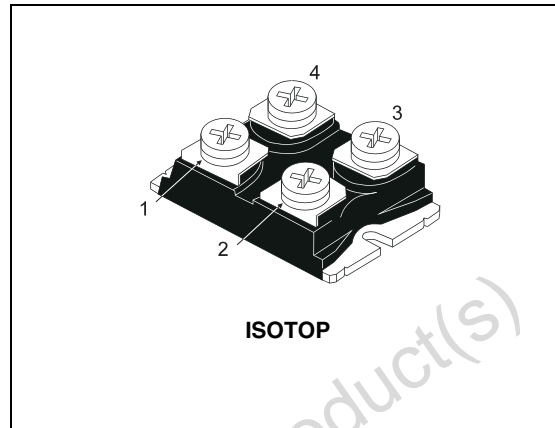
- 100% avalanche tested
- Low intrinsic capacitance
- Gate charge minimized
- Reduced voltage spread

## Description

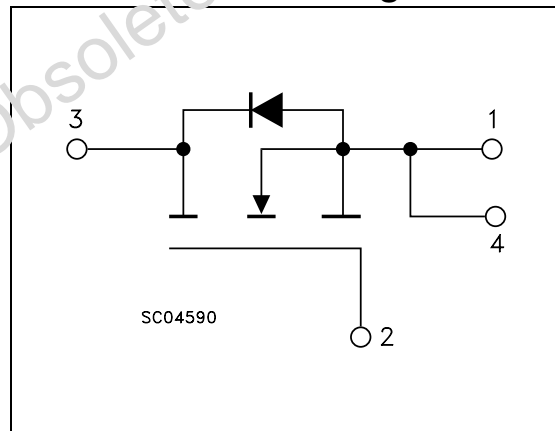
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## Applications

- Switching application



## Internal schematic diagram



## Order codes

Part number	Marking	Package	Packaging
STE180NE10	E180NE10	ISOTOP	Tube

## Contents

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# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage ( $V_{GS} = 0$ )	100	V
$V_{DGR}$	Drain-gate voltage ( $R_{GS} = 20k\Omega$ )	100	V
$V_{GS}$	Gate-source voltage	$\pm 20$	V
$I_D$	Drain current (continuous) at $T_C = 25^\circ\text{C}$	180	A
$I_D$	Drain current (continuous) at $T_C = 100^\circ\text{C}$	119	A
$I_{DM}^{(1)}$	Drain current (pulsed)	360	A
$P_{TOT}$	Total dissipation at $T_C = 25^\circ\text{C}$	360	W
	Derating factor	2.88	W/ $^\circ\text{C}$
$V_{ISO}$	Insulation withstand voltage (AC-RMS)	2500	V
$T_j$ $T_{stg}$	Operating junction temperature storage temperature	-55 to 150	$^\circ\text{C}$

1. Pulse width limited by safe operating area

**Table 2. Thermal data**

$R_{thj-case}$	Thermal resistance junction-case max	0.37	$^\circ\text{C}/\text{W}$
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**Table 3. Avalanche characteristics**

Symbol	Parameter	Max value	Unit
$I_{AR}$	Avalanche Current, Repetitive or Not-Repetitive (pulse width limited by $T_j$ max)	60	A
$E_{AS}$	Single Pulse Avalanche Energy (starting $T_j = 25^\circ\text{C}$ , $I_D = I_{AR}$ , $V_{DD} = 25\text{ V}$ )	720	mJ

## 2 Electrical characteristics

( $T_{CASE}=25^{\circ}C$  unless otherwise specified)

**Table 4. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1mA, V_{GS} = 0$	100			V
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{max rating}$ $V_{DS} = \text{max rating},$ $T_C = 125^{\circ}C$			4 40	$\mu A$ $\mu A$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20V$			$\pm 400$	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250\mu A$	2	3	4	V
$R_{DS(on)}$	Static drain-source on resistance	$V_{GS} = 10V, I_D = 40A$		4.5	6	$\Omega$

**Table 5. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}^{(1)}$	Forward transconductance	$V_{DS} > I_{D(on)} \times R_{DS(on)max}$ $I_D = 80 A$	30			S
$C_{iss}$	Input capacitance	$V_{DS} = 25V, f = 1MHz,$ $V_{GS} = 0$		21		nF
$C_{oss}$	Output capacitance			2.5		nF
$C_{rss}$	Reverse transfer capacitance			0.9		nF
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 90V, I_D = 490A$ $R_G = 4.7\Omega, V_{GS} = 10V$ (see <a href="#">Figure 12</a> )		100		ns
$t_r$	Rise time			600		ns
$t_{d(off)}$	Turn-off delay time			430		ns
$t_f$	Fall time			440		ns
$Q_g$	Total gate charge	$V_{DD} = 80V, I_D = 180A,$ $V_{GS} = 10V, R_G = 4.7\Omega$ (see <a href="#">Figure 13</a> )		585	795	nC
$Q_{gs}$	Gate-source charge			120		nC
$Q_{gd}$	Gate-drain charge			210		nC

1. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5%.

Table 6. Source drain diode

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$I_{SD}$	Source-drain current				180	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				540	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 180A, V_{GS} = 0$			1.5	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 100A,$ $di/dt = 100A/\mu s,$ $V_{DD} = 50V, T_j = 150^\circ C$ (see <a href="#">Figure 14</a> )		235		ns
$Q_{rr}$	Reverse recovery charge			1.65		$\mu C$
$I_{RRM}$	Reverse recovery current			14		A

1. Pulse width limited by safe operating area.
2. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5%

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## 2.1 Electrical characteristics (curves)

Figure 1. Safe operating area

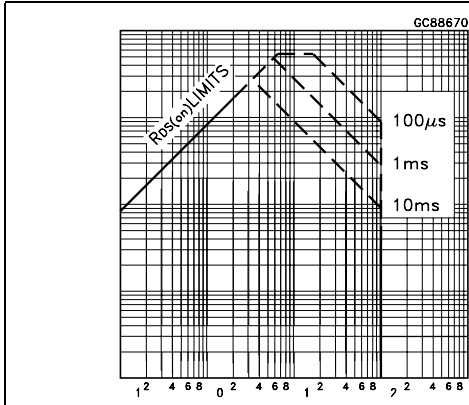


Figure 2. Thermal impedance

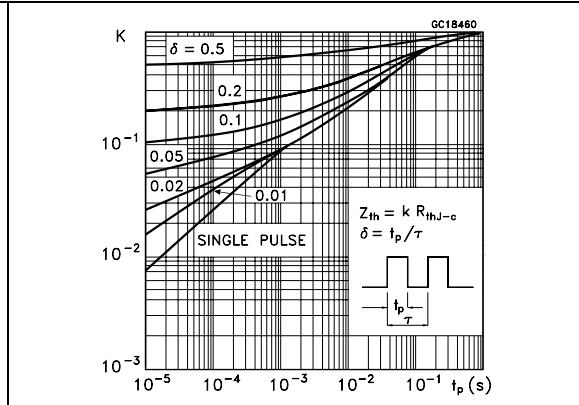


Figure 3. Output characteristics

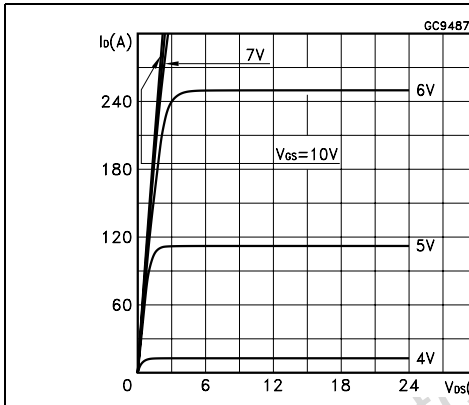


Figure 4. Transfer characteristics

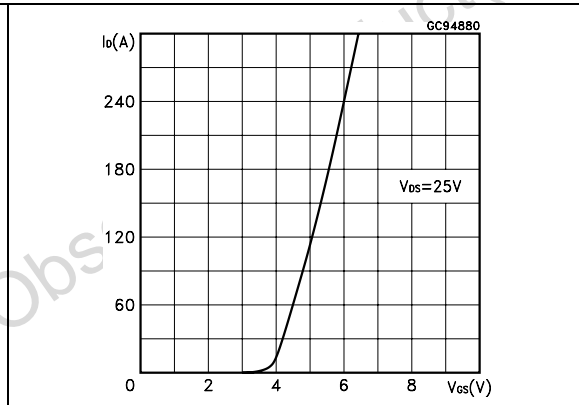


Figure 5. Transconductance

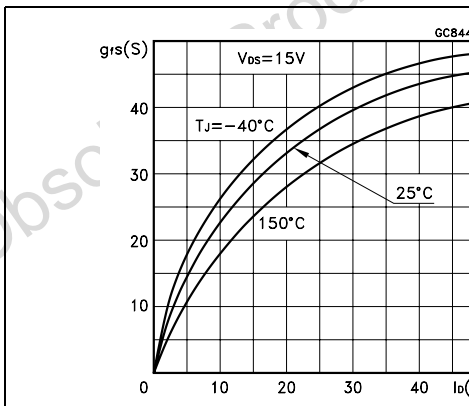


Figure 6. Static drain-source on resistance

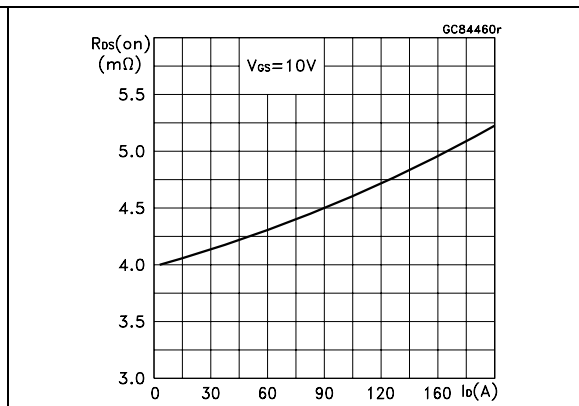


Figure 7. Gate charge vs. gate-source voltage Figure 8. Capacitance variations

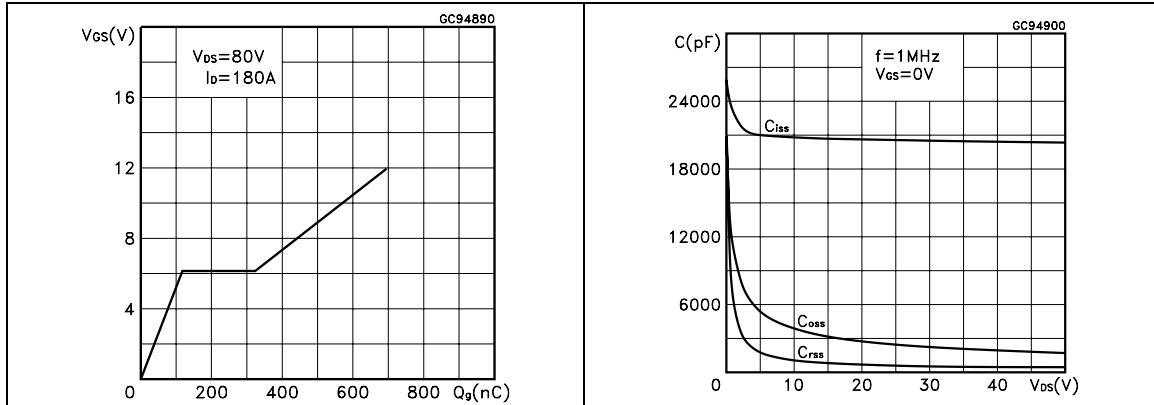


Figure 9. Normalized gate threshold voltage vs. temperature Figure 10. Normalized on resistance vs. temperature

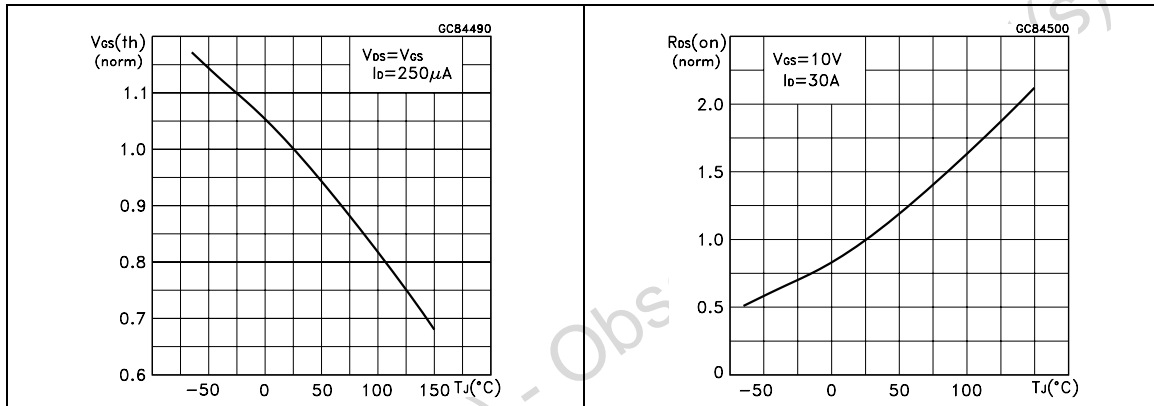
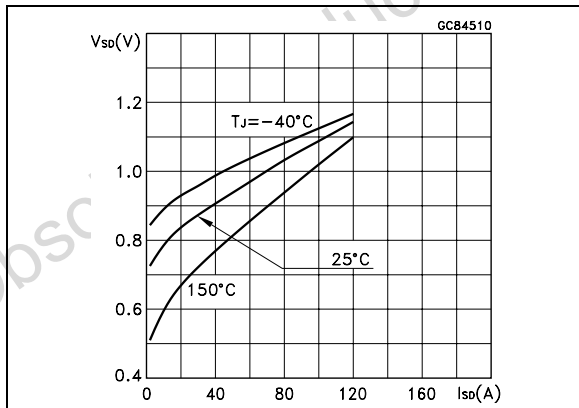


Figure 11. Source-drain diode forward characteristics



### 3 Test circuit

Figure 12. Switching times test circuit for resistive load

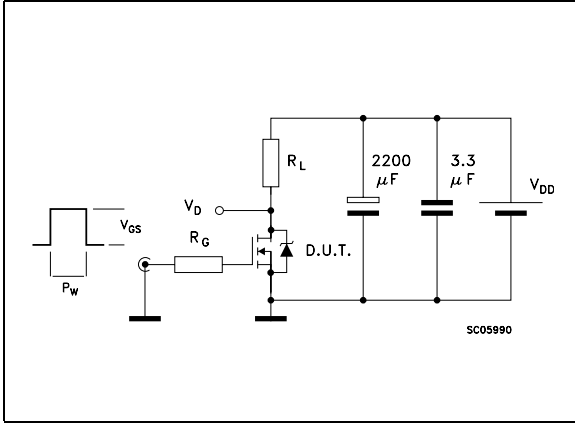


Figure 13. Gate charge test circuit

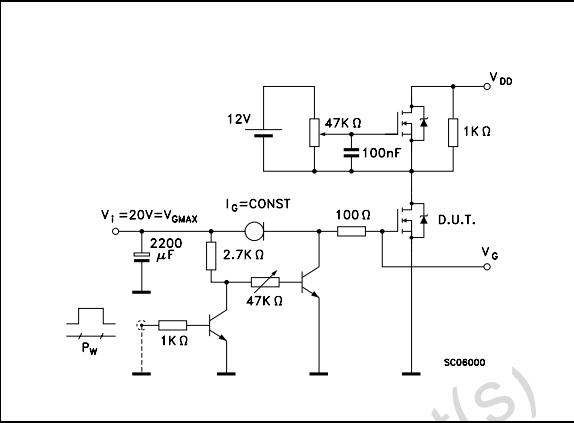


Figure 14. Test circuit for inductive load switching and diode recovery times

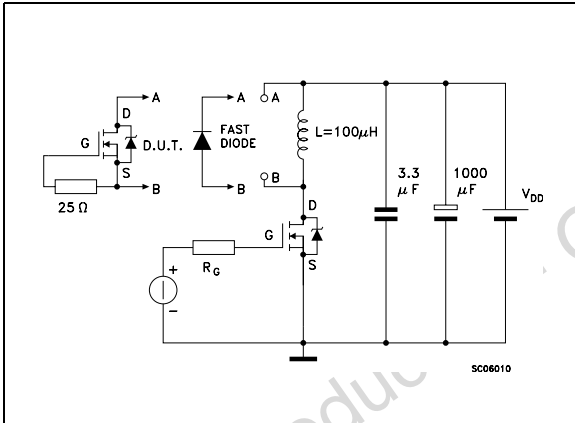


Figure 15. Unclamped Inductive load test circuit

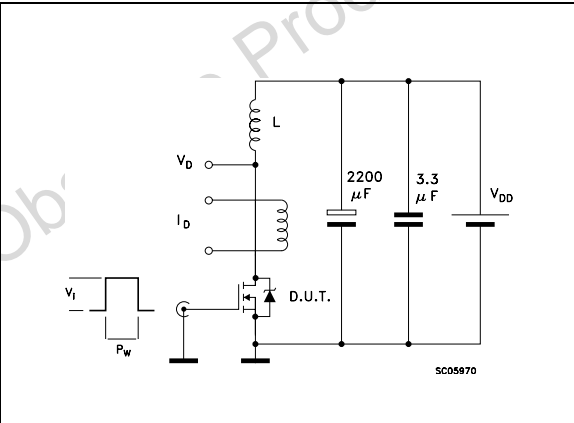


Figure 16. Unclamped inductive waveform

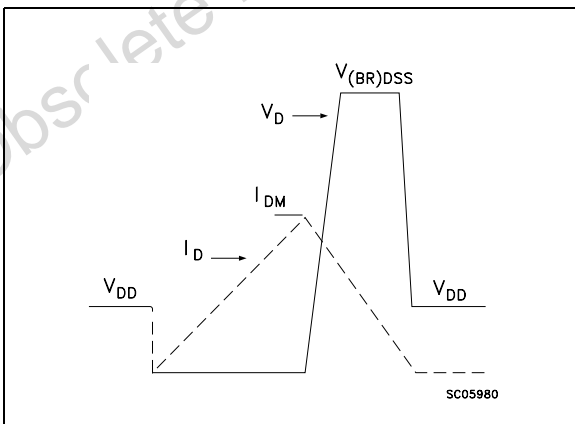
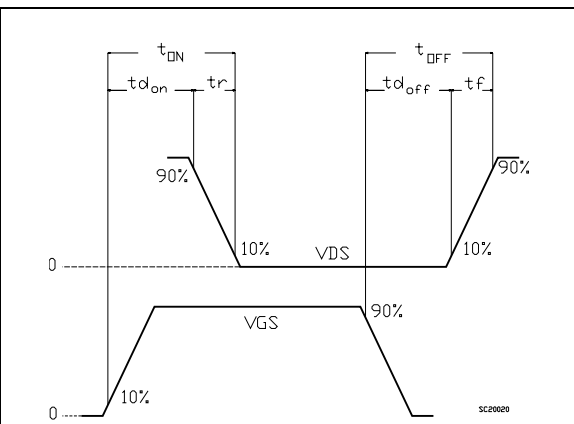


Figure 17. Switching time waveform





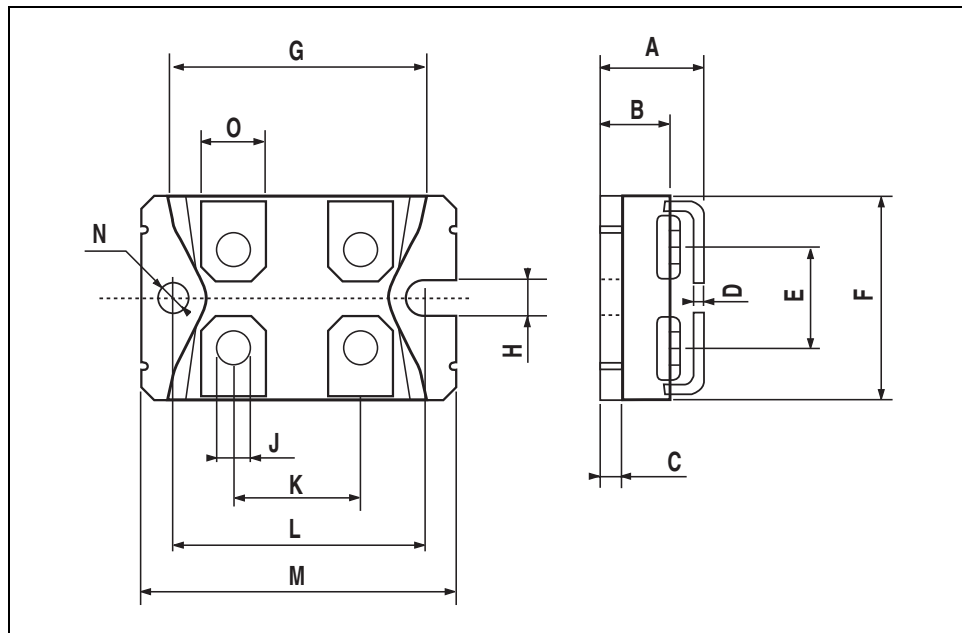
## 4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: [www.st.com](http://www.st.com)

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ISOTOP MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A	11.8		12.2	0.466		0.480
B	8.9		9.1	0.350		0.358
C	1.95		2.05	0.076		0.080
D	0.75		0.85	0.029		0.033
E	12.6		12.8	0.496		0.503
F	25.15		25.5	0.990		1.003
G	31.5		31.7	1.240		1.248
H	4			0.157		
J	4.1		4.3	0.161		0.169
K	14.9		15.1	0.586		0.594
L	30.1		30.3	1.185		1.193
M	37.8		38.2	1.488		1.503
N	4			0.157		
O	7.8		8.2	0.307		0.322



## 5 Revision history

Table 7. Revision history

Date	Revision	Changes
09-Sep-2004	4	Complete document
03-Aug-2006	5	New template, no content change
20-Feb-2007	6	Typo mistake on page 1

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